

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF FATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|-------------------------|-----------------------------------|----------------------|---------------------------|------------------|
| 09/502,126 | 02/10/2000 | HARI PONNEKANTI | AMAT/3984/PDD/LOW K/JW | 47 79 |
| 32588 | 7590 04/18/2003 | | | |
| APPLIED MATERIALS, INC. | | | EXAMINER | |
| | Г BLVD. M/S 2061 ARA, CA 95050 | | MOORE, KARLA A | |
| | | | ART UNIT | PAPER NUMBER |
| | | | 1763 | . |
| | | | DATE MAIL ED. 04/19/2002 | |

Please find below and/or attached an Office communication concerning this application or proceeding.

| | | | 14.C | | | | |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------|--|--|--|--|
| | | Application No. | Applicant(s) | | | | |
| Office Action Summary | | 09/502,126 | PONNEKANTI ET AL. | | | | |
| | | Examiner | Art Unit | | | | |
| | | Karla Moore | 1763 | | | | |
| The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply | | | | | | | |
| THE M - Extension - Extension - If the p - If NO p - Failure - Any rep | RTENED STATUTORY PERIOD FOR REPLY AILING DATE OF THIS COMMUNICATION. ons of time may be available under the provisions of 37 CFR 1.12 X (6) MONTHS from the mailing date of this communication. eriod for reply specified above is less than thirty (30) days, a reply eriod for reply is specified above, the maximum statutory period v to reply within the set or extended period for reply will, by statute ly received by the Office later than three months after the mailing patent term adjustment. See 37 CFR 1.704(b). | 36(a). In no event, however, may a r y within the statutory minimum of thin vill apply and will expire SIX (6) MON . Cause the application to become AF | reply be timely filed ty (30) days will be considered timely. ITHS from the mailing date of this communication. | | | | |
| 1)🖂 | Responsive to communication(s) filed on <u>03 F</u> | ebruary 2003 . | | | | | |
| | | is action is non-final. | | | | | |
| 3) 🗌 | | | | | | | |
| | closed in accordance with the practice under an of Claims | Ex parte Quayle, 1935 C.I | D. 11, 453 O.G. 213. | | | | |
| 4) \boxtimes Claim(s) <u>2-8,10-22 and 62-74</u> is/are pending in the application. | | | | | | | |
| 4a) Of the above claim(s) is/are withdrawn from consideration. | | | | | | | |
| 5) Claim(s) is/are allowed. | | | | | | | |
| 6)⊠ Claim(s) <u>2-8,10-22 and 62-74</u> is/are rejected. | | | | | | | |
| | 7) Claim(s) is/are objected to. | | | | | | |
| 8) Claim(s) are subject to restriction and/or election requirement. Application Papers | | | | | | | |
| 9)∐ Th | e specification is objected to by the Examiner | ·. | | | | | |
| 10)⊠ The drawing(s) filed on <u>03 April 2002</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner. | | | | | | | |
| Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). | | | | | | | |
| 11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner. | | | | | | | |
| If approved, corrected drawings are required in reply to this Office action. | | | | | | | |
| 12) The oath or declaration is objected to by the Examiner. | | | | | | | |
| Priority under 35 U.S.C. §§ 119 and 120 | | | | | | | |
| 13) 🗌 🗛 | knowledgment is made of a claim for foreign | priority under 35 U.S.C. § | 119(a)-(d) or (f). | | | | |
| | All b)☐ Some * c)☐ None of: | | | | | | |
| 1. | Certified copies of the priority documents | have been received. | | | | | |
| 2. | Certified copies of the priority documents | have been received in Ap | oplication No | | | | |
| Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | |
| 14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application). | | | | | | | |
| a) The translation of the foreign language provisional application has been received. 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. | | | | | | | |
| Attachment(s) | 5 Samuel C. 2 Sami for domestic | Friency under 00 0,0.0. | 33 120 dilakor 121. | | | | |
| 2) 🔲 Notice of | References Cited (PTO-892) Draftsperson's Patent Drawing Review (PTO-948) On Disclosure Statement(s) (PTO-1449) Paper No(s) | 5) Notice of In | ummary (PTO-413) Paper No(s) formal Patent Application (PTO-152) | | | | |

Art Unit: 1763

DETAILED ACTION

Claim Objections

Claims 1, 9 and 12 are objected to because of the following informalities: Looking at the remarks 1. present in the amendment and the marked-up version of the amendment, it appears that these claims were meant to be cancelled and the application has been examined as such. However, the claims have not been formally cancelled on page 2 of the amendment where all other changes to the claims are listed. Appropriate correction is requested.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- Claims 2-4, 10-11, 13-16, 20, 22 and 62-67 are rejected under 35 U.S.C. 103(a) as being 3. unpatentable over U.S. Patent No. 5,769,952 to Komino in view of U.S. Patent No. 5,858,108 to Hwang.
- Komino discloses an apparatus for processing substrates, the apparatus comprising: a high 4. pressure processing module (120) including a first plurality of substrate processing chambers (18 A-C), a first transfer chamber (20) that enables access to each of the first plurality of substrate processing chambers, and a first substrate handling member (22) disposed in the first transfer chamber and configured to transfer substrates into and out of any of said first plurality of substrate processing chambers, wherein at least one of the chambers is capable of being used as a liquid precursor deposition chamber; a low pressure processing module (100) including a second plurality of substrate processing chambers (10 A-C), a second transfer chamber (14) that enables access to each of the second plurality of substrate processing chambers, and a second substrate handling member (16) disposed in the second

Art Unit: 1763

transfer chamber and configured to transfer substrates into and of any of said second plurality of substrate processing chambers; wherein said second plurality of substrate processing chambers includes at least one chemical vapor deposition chamber (column 5, rows 48-51); and a transfer area (130A and 130B) that enables substrates to be transferred between the high pressure processing module and the low pressure processing module.

- 5. With respect to claim 2, Komino further discloses that the transfer areas may be used for heating and/or cooling (column 7, rows 18-20) and that the areas may house a plurality of treatment objects, if desired (column 11, rows 38-48).
- 6. With respect to claims 3-4 and 15-16, the transfer area (column 7, rows 10-18) and each of the second plurality of chambers (column 5, rows 14-22 and column 8, rows 57-61) are in fluid communication with a vacuum pump. Examiner notes that while Komino does not explicitly mention the vacuum pump, it is made clear that each of these area are capable of being held at a vacuum and therefore they must be fluidly connected to a vacuum pump.
- 7. With respect to claim 10, the high pressure-processing module may comprise at least one substrate stripping/cleaning module (column 6, rows 10-14).
- 8. With respect to claim 11, the transfer area comprises a loadlock chamber (130A and 130B; column 6, rows 61-64).
- 9. With respect to the recitation that at least one of the processing chambers is dedicated to performing a liquid deposition process (claim 64). Komino teaches that each of the chambers (18A and 18C) is designed to dispense a liquid into the high pressure chamber and therefore would be capable of being used as a deposition chamber. Komino also notes that each of the chambers is not limited to the treatments explicitly described and that alternative constructions are possible according to the types of treatment required before or after low pressure treatment (see column 6, rows 7-35).
- 10. With respect to claims 13 and 20 which include limitations primarily directed towards intended uses of the high pressure processing chambers (spinning, curing, stripping and silylation), the high pressure chambers of Komino are taught as being used for and/or capable of spinning, curing, stripping or deposition. Recitations of a deposition chamber specifically for silylation and a stripping chamber

specifically for oxidation are viewed as an intended uses of the chambers, which contain no structural distinctions over the prior art. Examiner also notes that each of the high pressure chambers is capable of supplying a gas (column 6, rows 36-42).

- 11. The courts have ruled that expressions relating the apparatus to contents thereof during an intended operation are of no significance in determining the patentability of the claim. Ex parte Thibault, 164 USPQ 666, 667 (Bd. App. 1969).
- 12. With respect to claims 14, 22 and 66-67, as noted above the two loadlock transfer chambers between the high pressure and low pressure processing modules may be configured as multi-slot preheating and/or cooling chambers.
- 13. With respect to claims 62 and 63, an isolated processing region of each of said second plurality of chambers (using gate valves 12 A-C) and an interior region of said high pressure deposition module (using an inert gas, column 6, rows 39-42) are isolatable from an exterior environment in which said apparatus is situated.
- 14. With respect to claim 65, as noted above, at least one of the high pressure chambers is capable of deposition. Further, Komino teaches that spinning may be used during treatment (column 6, rows 21-22).
- 15. Komino discloses the invention substantially as claimed and as described above.
- 16. However, Komino fails to disclose a loadlock chamber operatively coupled to the low pressure-processing module to enable transfer of substrates between the apparatus and a clean room (claim 64) or a loadlock chamber operatively coupled to the high-pressure module to enable transfer of substrates between the apparatus and a clean room (claim 66).
- 17. Hwang teaches the use of a loadlock chamber as a buffer chamber between a processing environment and the atmosphere for the purpose of removing dust particles from the substrate (abstract and column 1, rows 54-61) prior to entry into the processing environment.
- 18. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided a loadlock chamber coupled to a low pressure processing module or high

pressure processing module in Komino in order to use the loadlock as a buffer chamber for removing dust prior to the entry of a substrate into a processing environment as taught by Hwang.

- 19. Claims 5-6 and 17-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Komino and Hwang as applied to claims 2-4, 10-11, 13-16, 20, 22 and 62-67 above, and further in view of U.S. Patent to No. 6,214,620 to Kim.
- 20. The prior art discloses the invention substantially as claimed and as described above.
- 21. However, the prior art fails to teach each of the second plurality of processing chambers has two isolated processing regions and each isolated processing region includes a gas distribution assembly disposed therein and each gas distribution assembly shares process gases from one or more gas sources.
- 22. Kim discloses a processing chamber (Figure 2) comprising two processing regions, each region includes a gas distribution assembly (not numbered) and each gas distribution assembly sharing process gases from one or more sources for the purpose of configuring a machine with a small footprint and increased throughput, as compared to a single region system (column 1, rows 50-60).
- 23. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided an apparatus with two processing regions with a gas distribution assembly in each region and each sharing process gases from one or more sources in Turner et al. in order to configure a machine with a small footprint and increased throughput as taught by Kim.
- 24. Claims 7-8 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Komino, Hwang and Kim as applied to claims 5-6 and 17-18 above, and further in view of U.S. Patent No. 5,587,038 to Cecchi et al.
- The prior art discloses the invention substantially as claimed and as described above.
- 26. However, the prior art fails to teach a remote plasma system having an RF generator connected to each individual processing region.

27. Cecchi et al. teach the use of a remote plasma system in a processing chamber having an RF generator, wherein the remote plasma system is connected to and in fluid communication with the processing region because plasma generation is useful in a variety of fabrication processes (column 1, rows 14-16) and located remotely for the purpose of allowing the aspect ration of the processing chamber to be increased and improving processing conditions, such as pumping speed, reaction product exhaust, control of wall chemistry and the like (column 4, rows 7-21).

- 28. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided a remote plasma system connected to and in fluid communication with each processing chamber in the prior art due to its usefulness in a variety of fabrication processes and to have the system located remotely in order to allow optimization of aspect ration and other process conditions as taught by Cecchi et al.
- 29. Claim 21 is rejected under 35 U.S.C. 103(a) as being unpatentable over Komino and Hwang as applied to claims 2-4, 10-11, 13-16, 20, 22 and 62-67 above, and further in view of U.S. Patent No. 5,587,038 to Cecchi et al.
- 30. The prior art discloses the invention substantially as claimed and as described above.
- 31. However, the prior art fails to teach a remote plasma system having an RF generator connected to an individual processing region.
- 32. Cecchi et al. teach the use of a remote plasma system in a processing chamber having an RF generator, wherein the remote plasma system is connected to and in fluid communication with the processing region because plasma generation is useful in a variety of fabrication processes (column 1, rows 14-16) and located remotely for the purpose of allowing the aspect ration of the processing chamber to be increased and improving processing conditions, such as pumping speed, reaction product exhaust, control of wall chemistry and the like (column 4, rows 7-21).
- 33. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided a remote plasma system connected to and in fluid communication with a processing chamber in the prior art due to its usefulness in a variety of fabrication processes and to have

Art Unit: 1763

the system located remotely in order to allow optimization of aspect ration and other process conditions as taught by Cecchi et al.

- 34. Claims 68-72 rejected under 35 U.S.C. 103(a) as being unpatentable over Komino and Hwang as applied to claims 2-4, 10-11, 13-16, 20, 22 and 62-67 above, and further in view of Japanese Patent No. 11-087467 A and U.S. Patent No. 6,318,945 to Hofmeister.
- 35. The prior art discloses the invention substantially as claimed and as described above.
- 36. However, the prior art fails to disclose a multi-slot substrate preheating module/loadlock with vertically isolatable and movable compartments.
- 37. Saeki discloses a multi-slot loadlock chamber comprising: a housing (31) including an opening (31A); a first compartment (33), the first compartment being operatively coupled to a first moveable shaft (33E); and a substrate transfer region (between 33 and 32) where substrates can be transferred into or out of the first compartment of the module through the opening in the housing; wherein the first compartment is moveable within the housing to expose an interior section of the compartment to the opening.
- 38. Regarding claim 69, the compartment is moveable between a substrate loading /unloading position that exposes the interior section of the first compartment to the opening and an isolation position where the compartment is isolated from the atmosphere in the substrate transfer region.
- 39. With respect to claim 70, the module further comprises first (31F) and second (31E) sealing flanges disposed peripherally within and extending inward from the housing and wherein the first compartment comprises a bottom platform (33C), a top platform (31D) and wherein when the first compartment is in the isolation position the top platform engages the first sealing flange and the bottom flange engages the second sealing flange.
- 40. With respect to claim 71, a second compartment (32), the second compartment being operatively coupled to a second moveable shaft (32E) so that it is moveable within the housing to expose an interior section of the compartment to the opening.

Page 7

Art Unit: 1763

- 41. With respect to claim 72, the second compartment is movable similar to the first compartment between the opening and an isolation region.
- 42. With respect to claim 73, the module comprises first and second flanges as described above as well as, third (31D) and fourth (31C) sealing flanges disposed peripherally within and extending inward from the housing; wherein the first compartment comprises a first bottom platform and a first top platform and wherein when the first compartment is in the isolation position the first top platform engages the first sealing flange and the first bottom platform engages the second sealing flange; and wherein the second compartment comprises a second bottom platform (32H) and a second top platform (32D) and wherein when the second compartment is in the isolation position the second top platform engages the third sealing flange and the second bottom platform engages the fourth sealing flange.
- 43. With respect to claim 74, when each of the first and second compartments are positioned in the isolation position, the compartments are spaced apart from each other in a vertical relationship and the transfer region is located between the compartments.
- 44. The module of Saeki is constructed as described above for the purpose of reducing the footprint of the module and as a result raising the flexibility of the layout of a processing room (effect of the invention paragraph 37, see translation of provided by JPO website).
- 45. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided a loadlock as described above in the prior art in order to reduce the footprint of the module and as a result raising the flexibility of the layout of a processing room as taught by Saeki et al.
- 46. Saeki and the prior art fail to teach supports for each of the compartments that support the platforms in a spaced relationship or for any other purpose.
- 47. Hofmeister et al. teach the use of supports (58 and 68) in a vertical multi-chamber loadlock for the purpose of supporting individual substrates in a spaced configuration (column 3, row 67 through column 4, rows 1). The supports would also necessarily maintain the platforms in a spaced relationship.

Art Unit: 1763

48. It would have been obvious to one of ordinary skill in the art at the time the Applicant's invention was made to have provided supports in each compartment of a loadlock chamber in order to support individual substrates in a spaced configuration as taught by Hofmeister.

Response to Arguments

49. Applicant's arguments with respect to claims 2-8, 10-11, 12-22 and 62-74 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

- 50. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.
- 51. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Karla Moore whose telephone number is 703.305.3142. The examiner can normally be reached on Monday-Friday, 8:30am-5:30pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Gregory Mills can be reached on 703.308.1633. The fax phone numbers for the organization where this

Art Unit: 1763

Page 10

application or proceeding is assigned are 703.872.9310 for regular communications and 703.872.9311 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703.308.0661.

km April 16, 2003

> sàrive p. beck Supervisory patent examiner

TECHNOLOGY CERTER 1700